

FIG. 1B

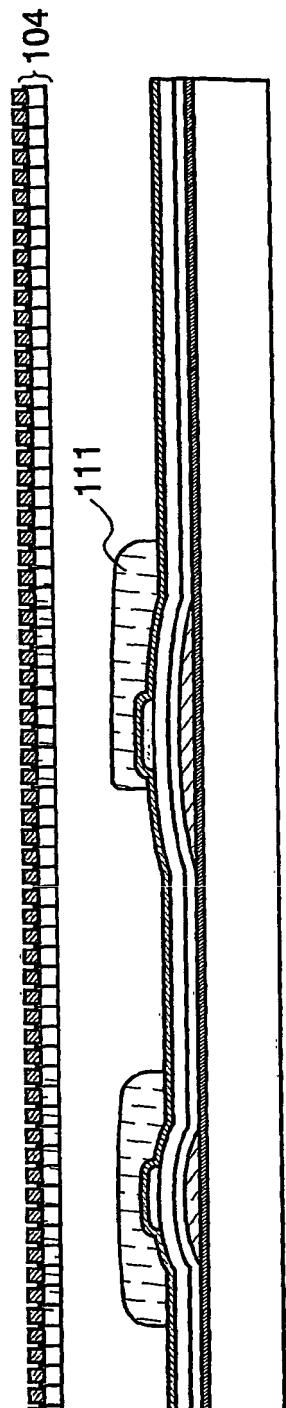


FIG. 1C

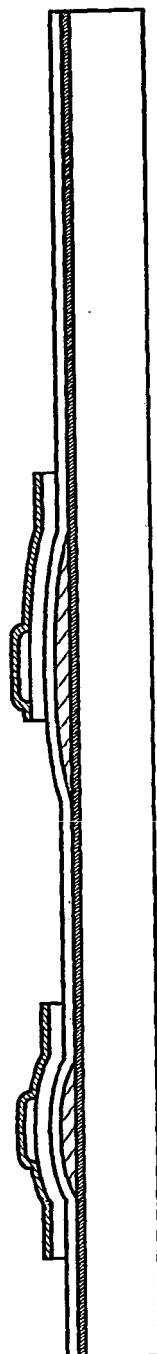
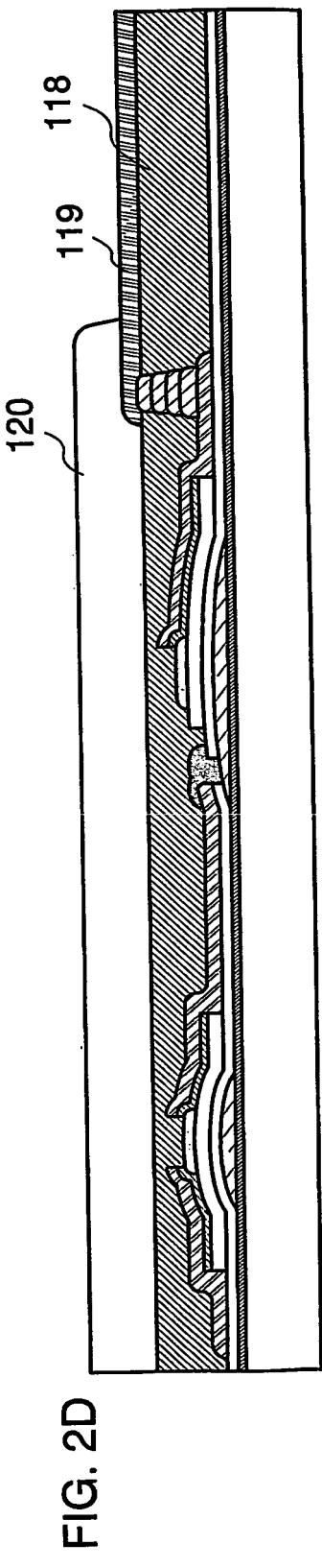
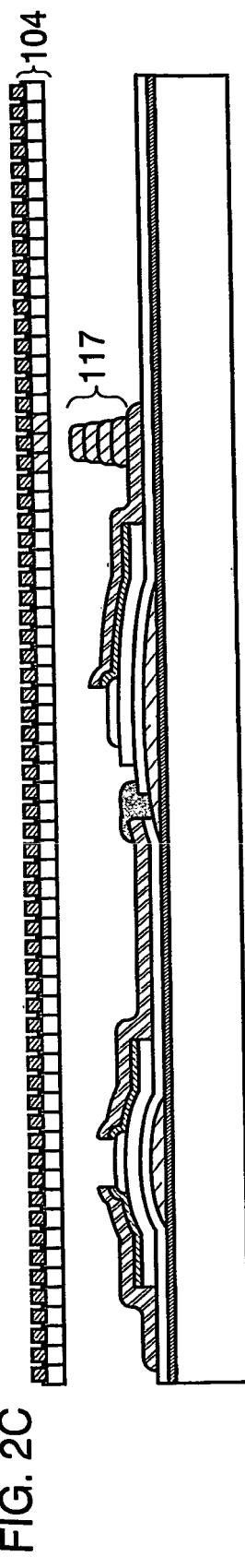
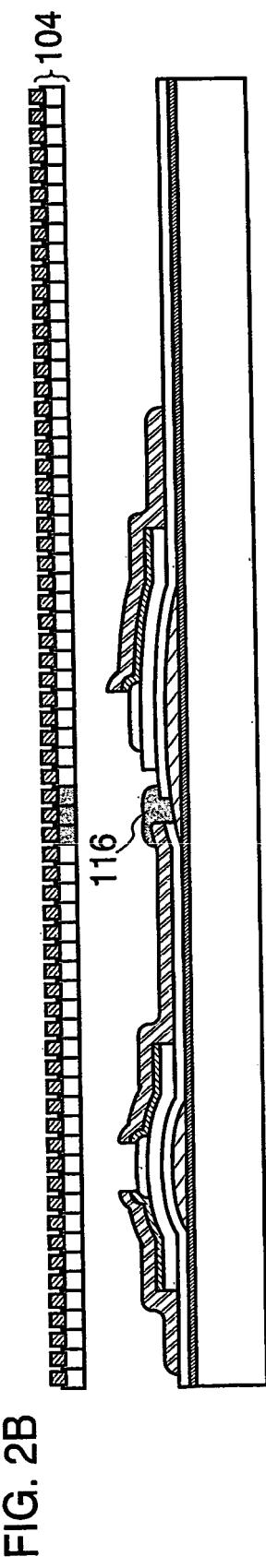
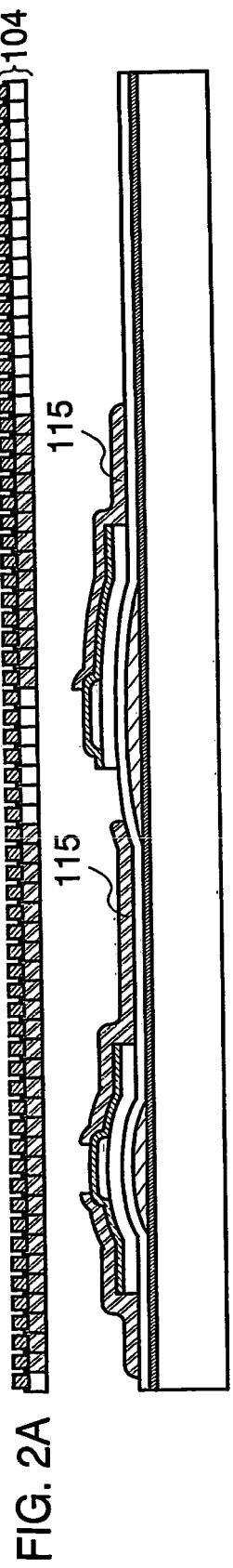
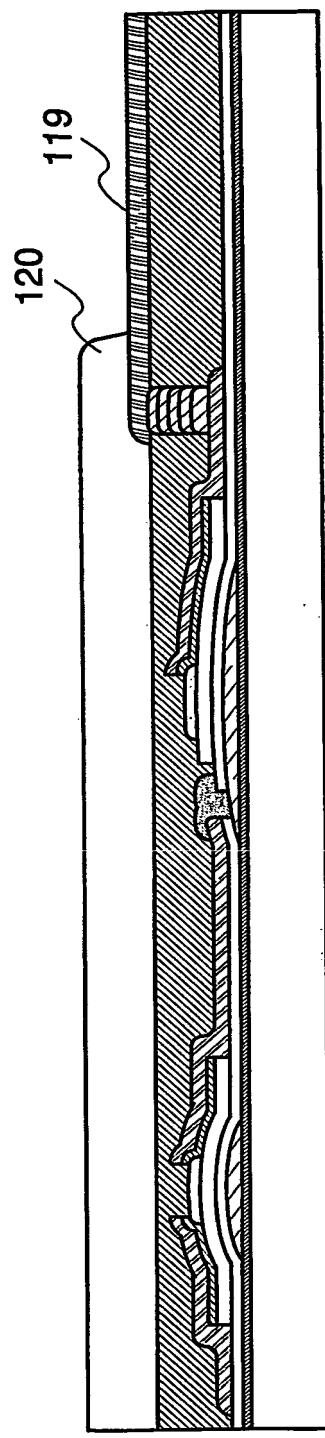
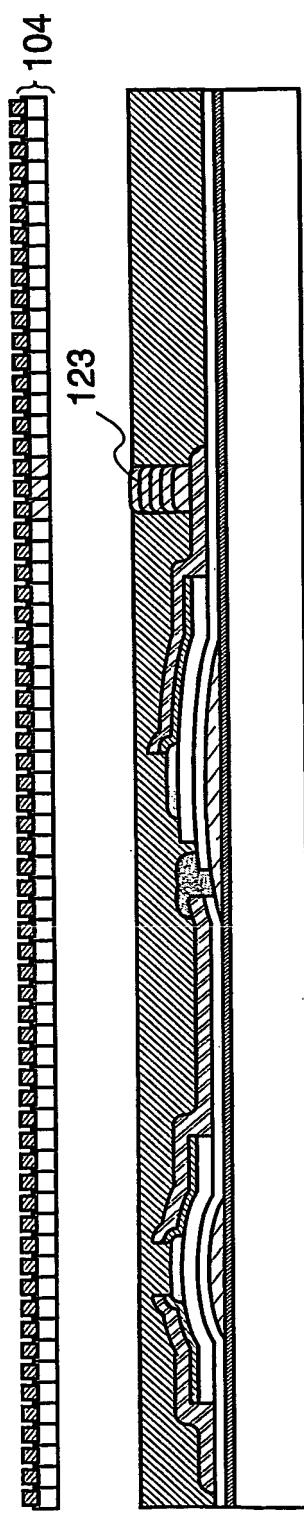
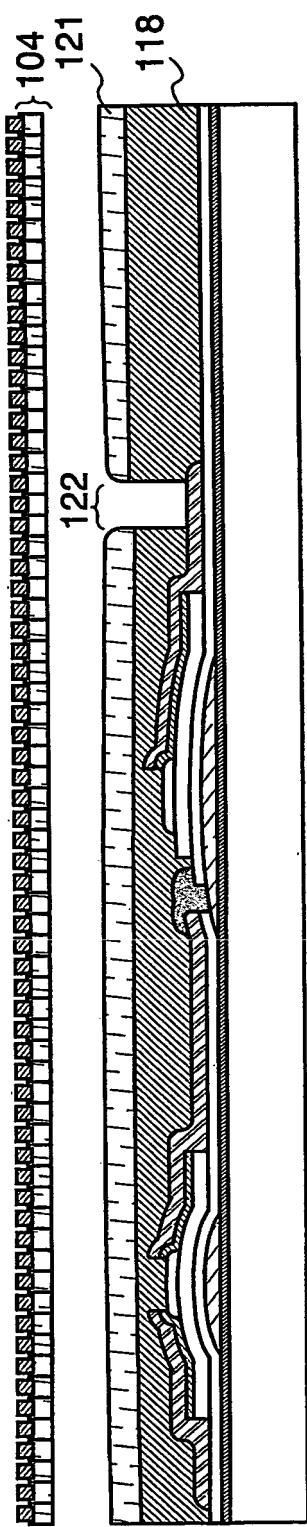
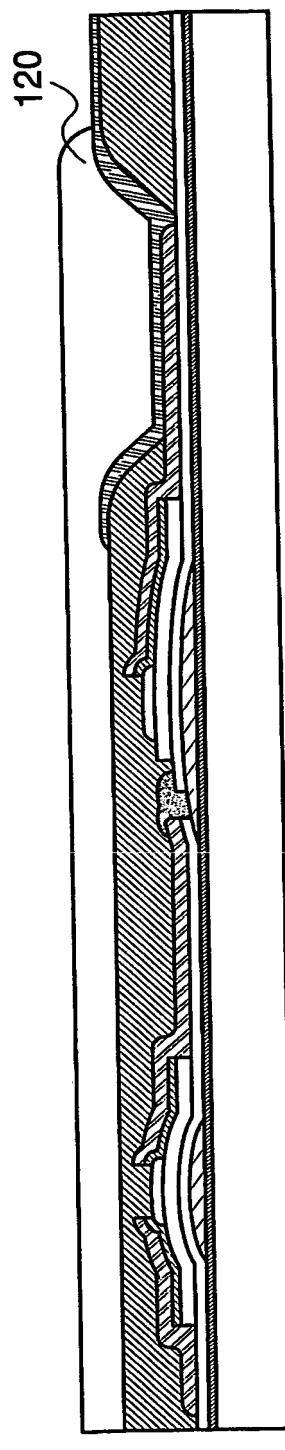
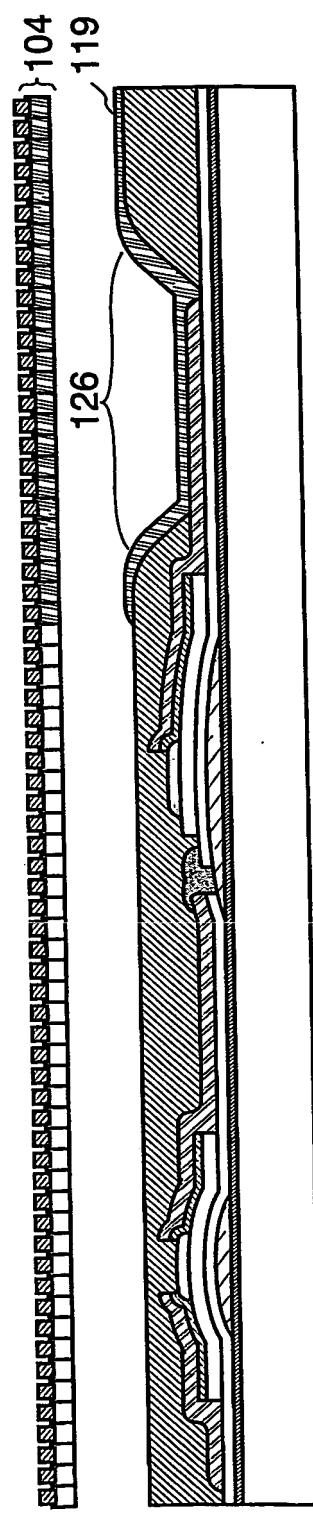
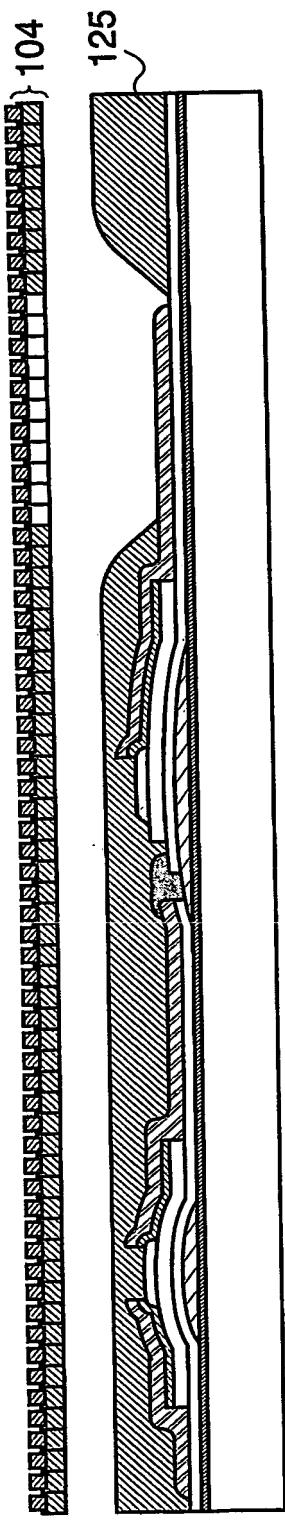


FIG. 1D







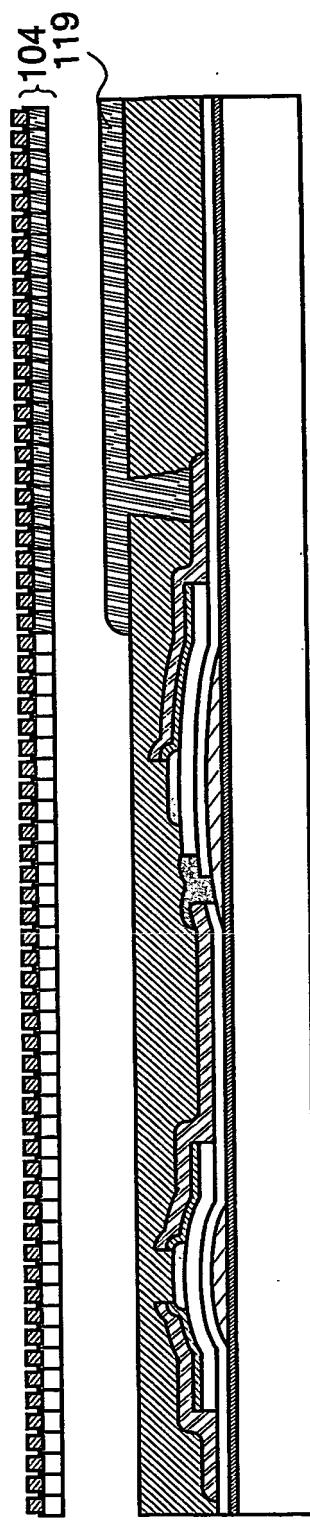
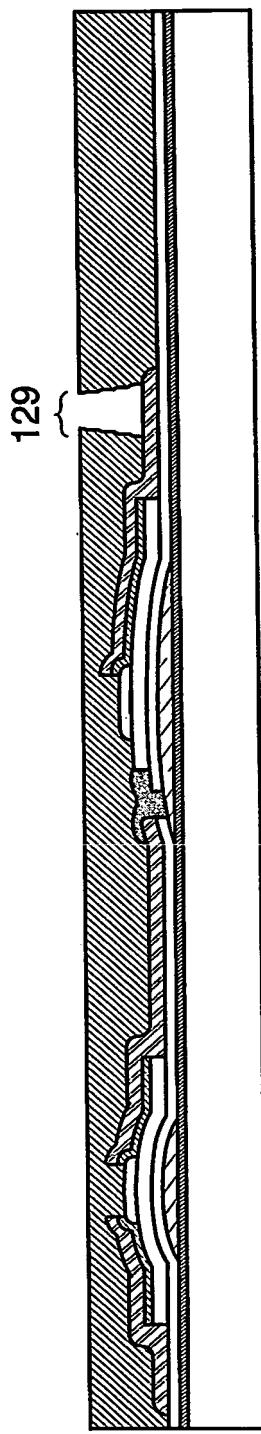
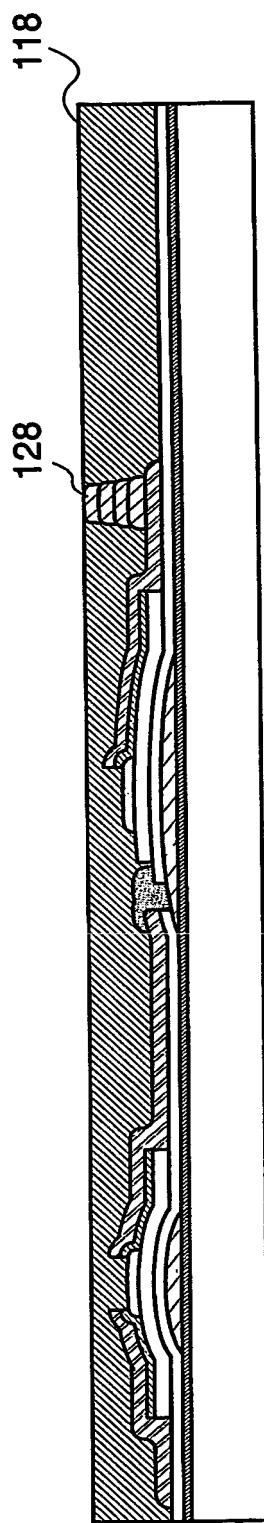


FIG. 6A

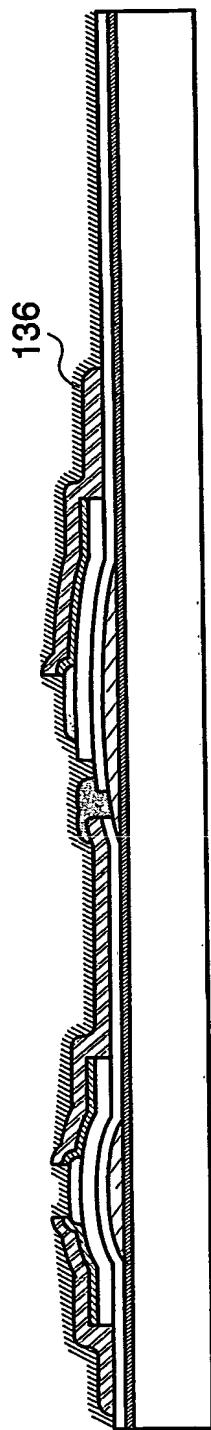


FIG. 6B



FIG. 6C

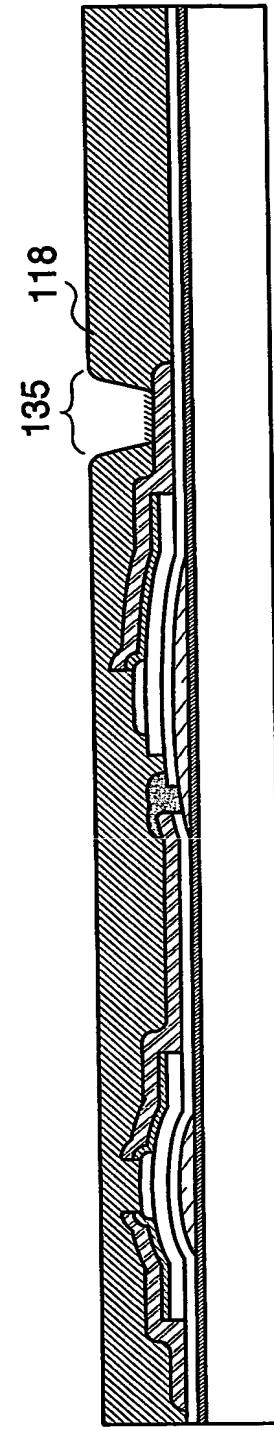
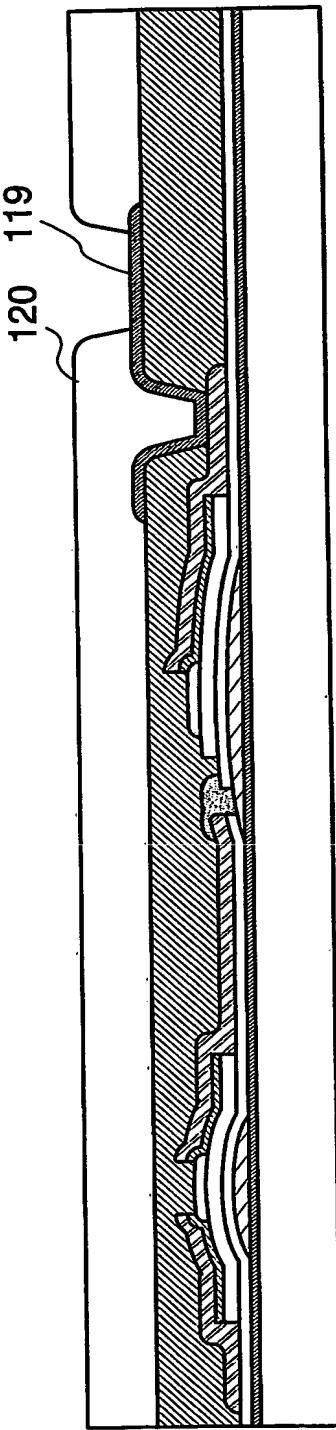


FIG. 6D



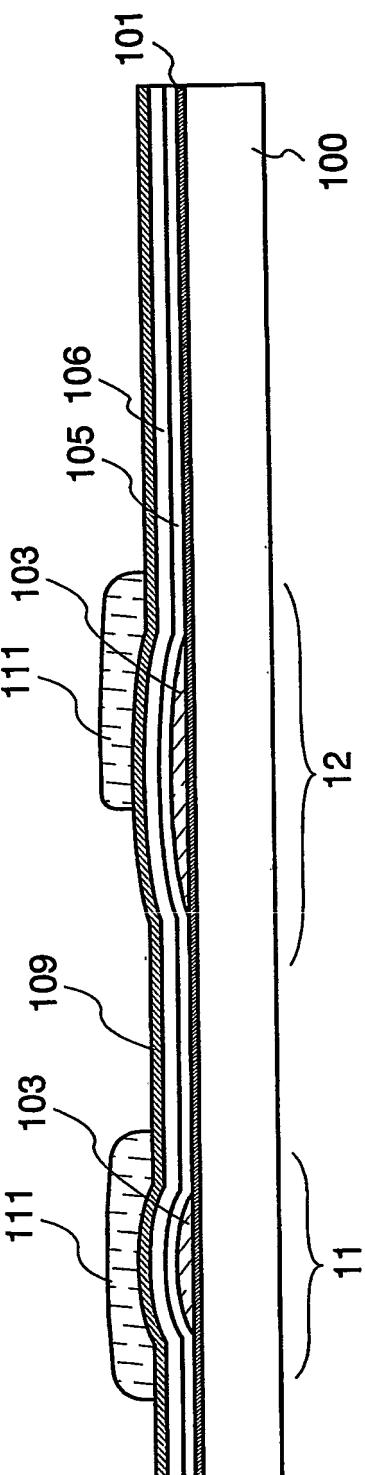


FIG. 7A

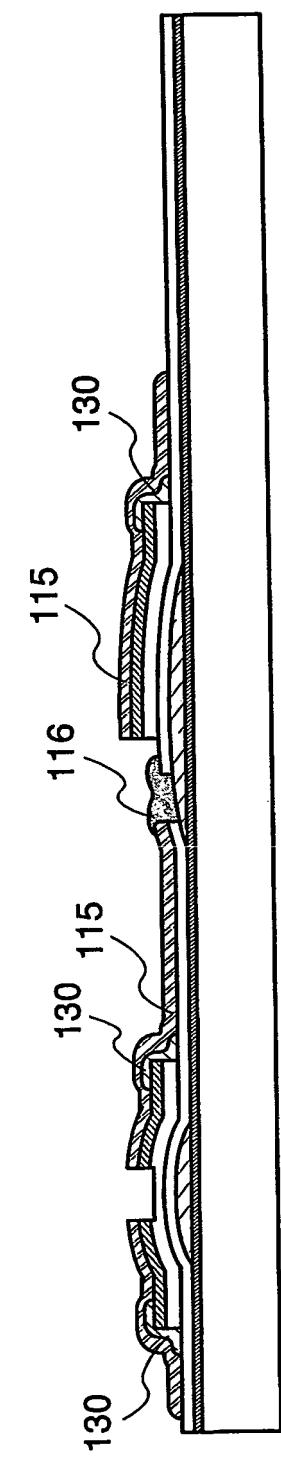


FIG. 7B

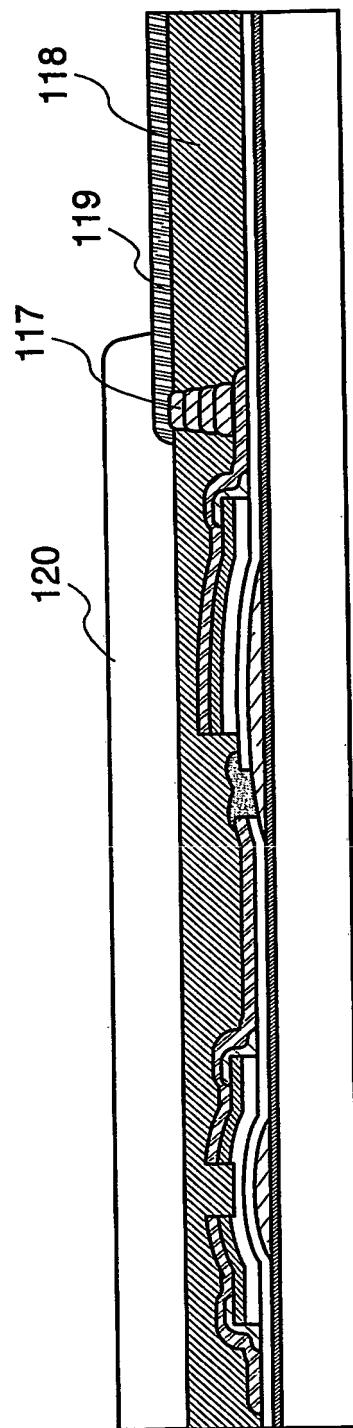


FIG. 7C

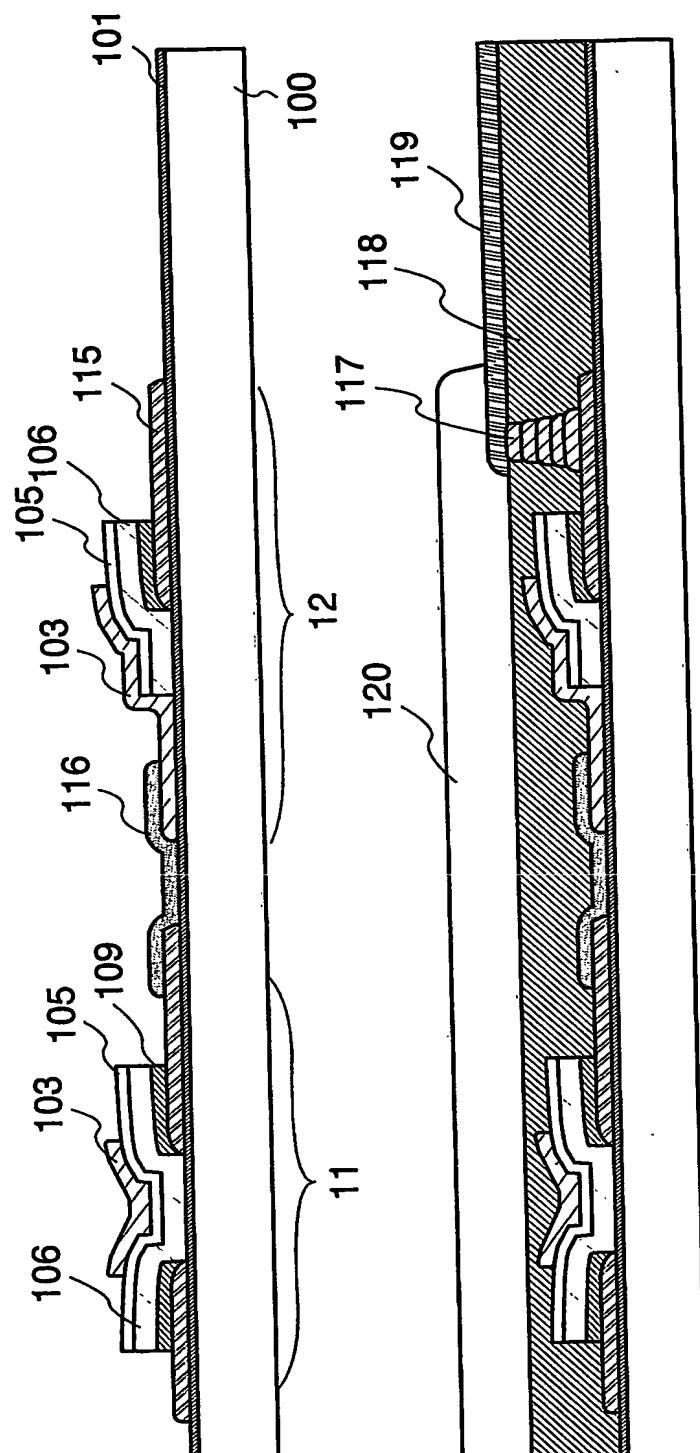


FIG. 8A

FIG. 8B

FIG. 9A

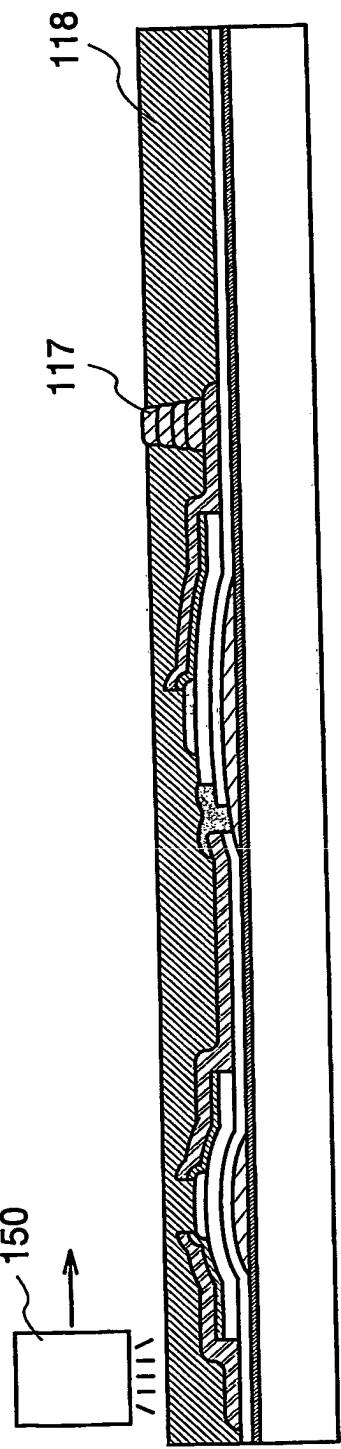


FIG. 9B

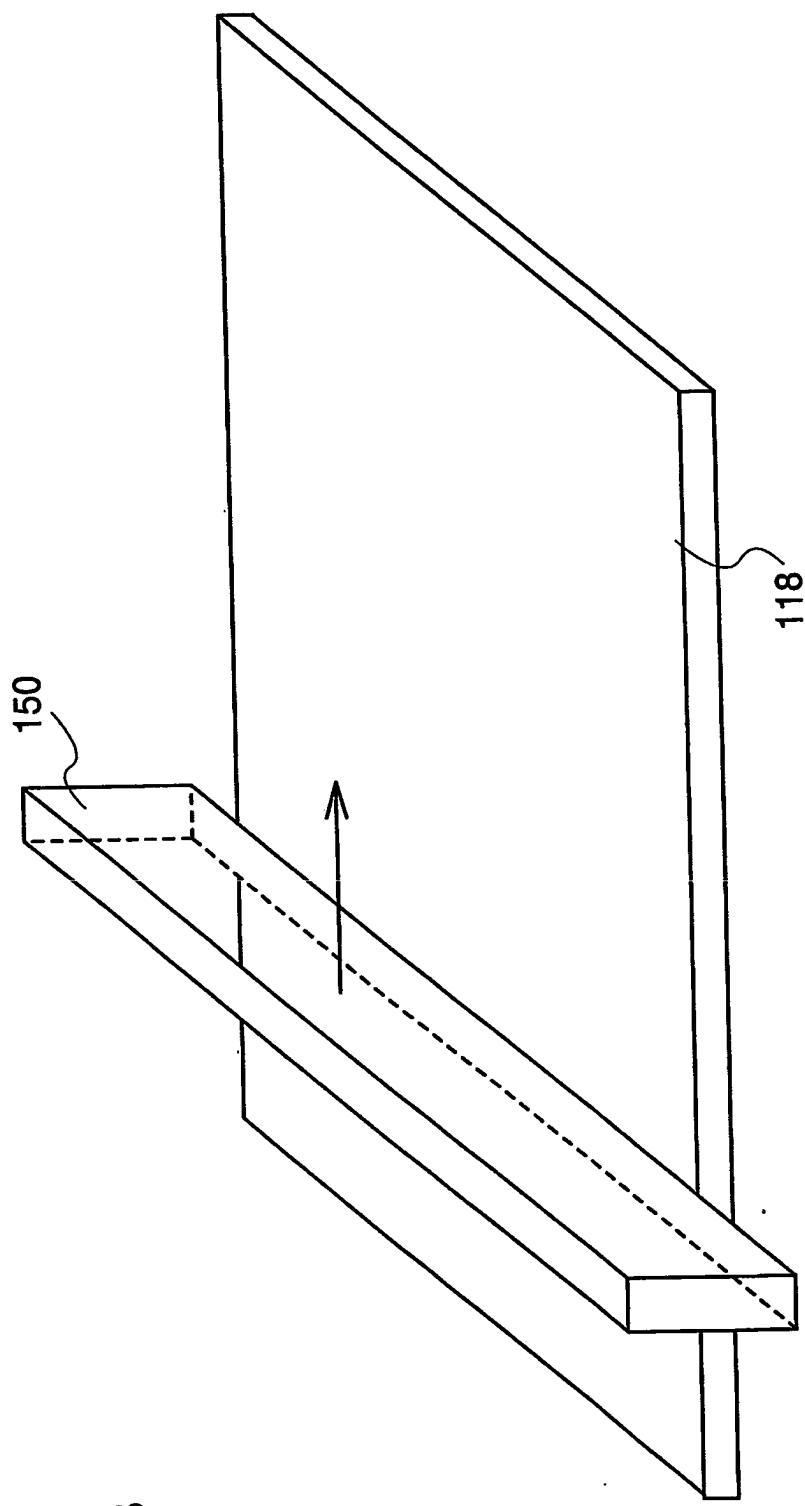


FIG. 10

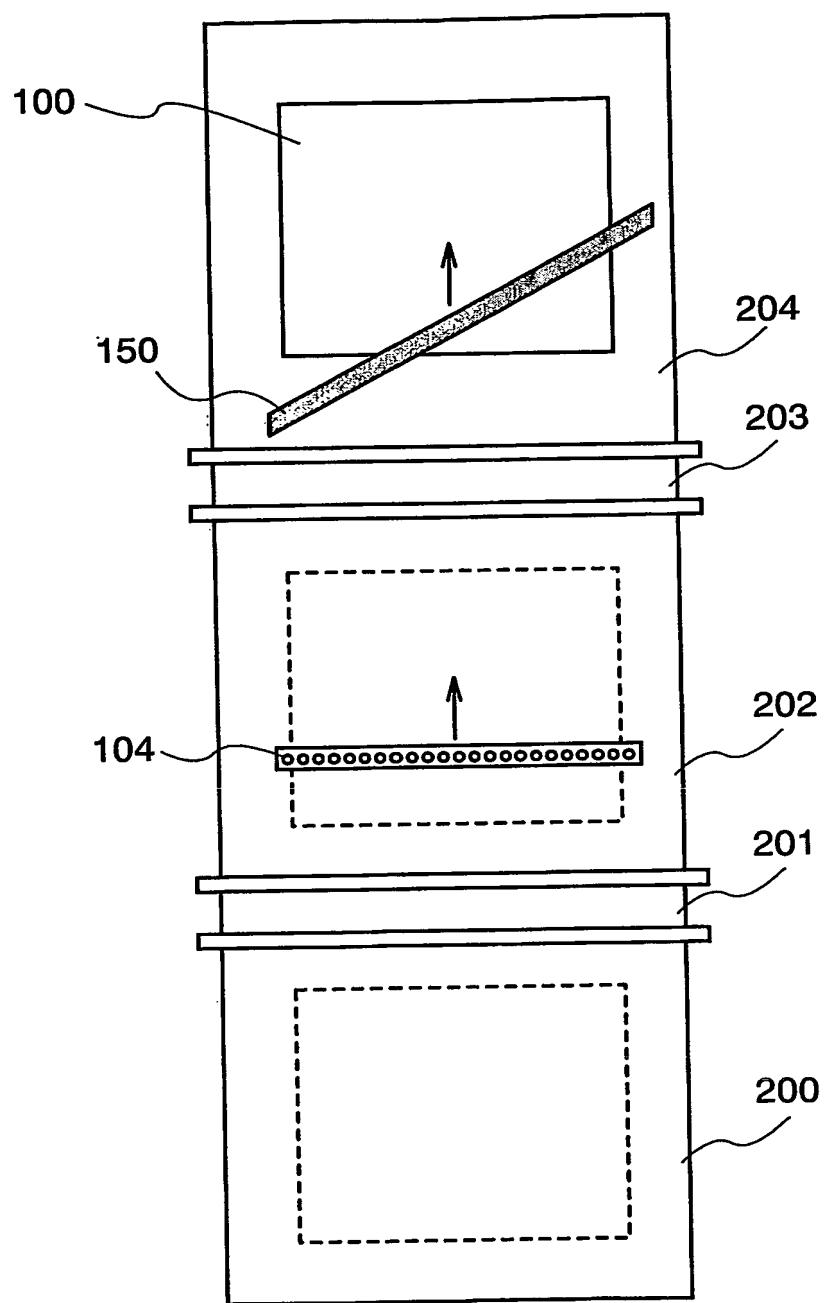


FIG. 11A

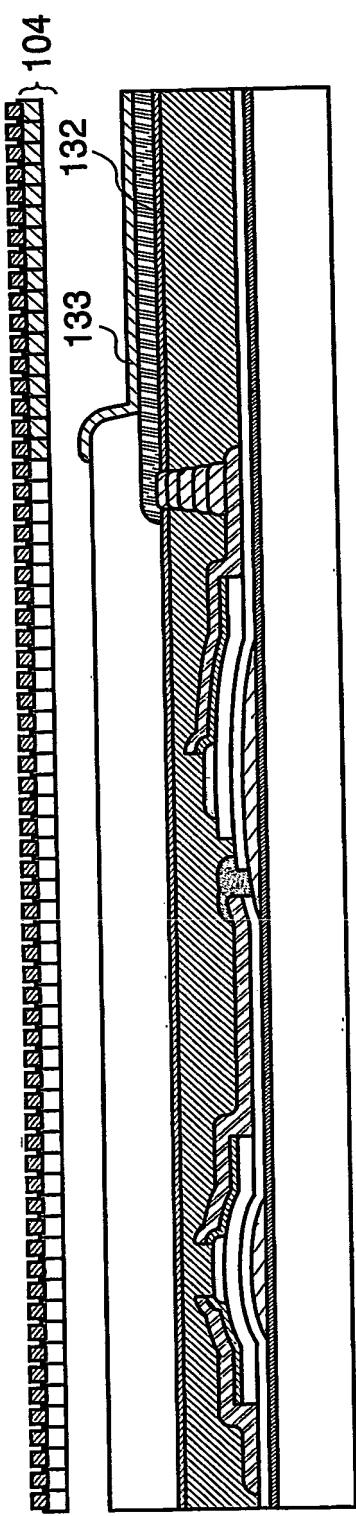


FIG. 11B

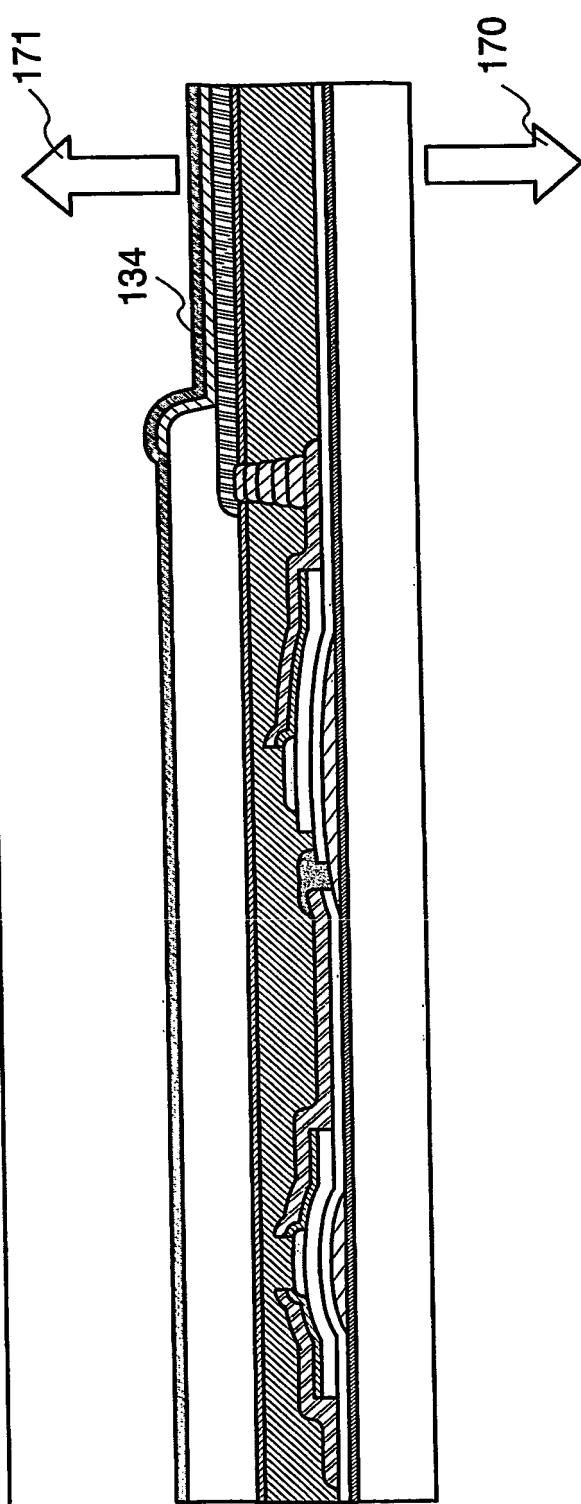


FIG. 12A

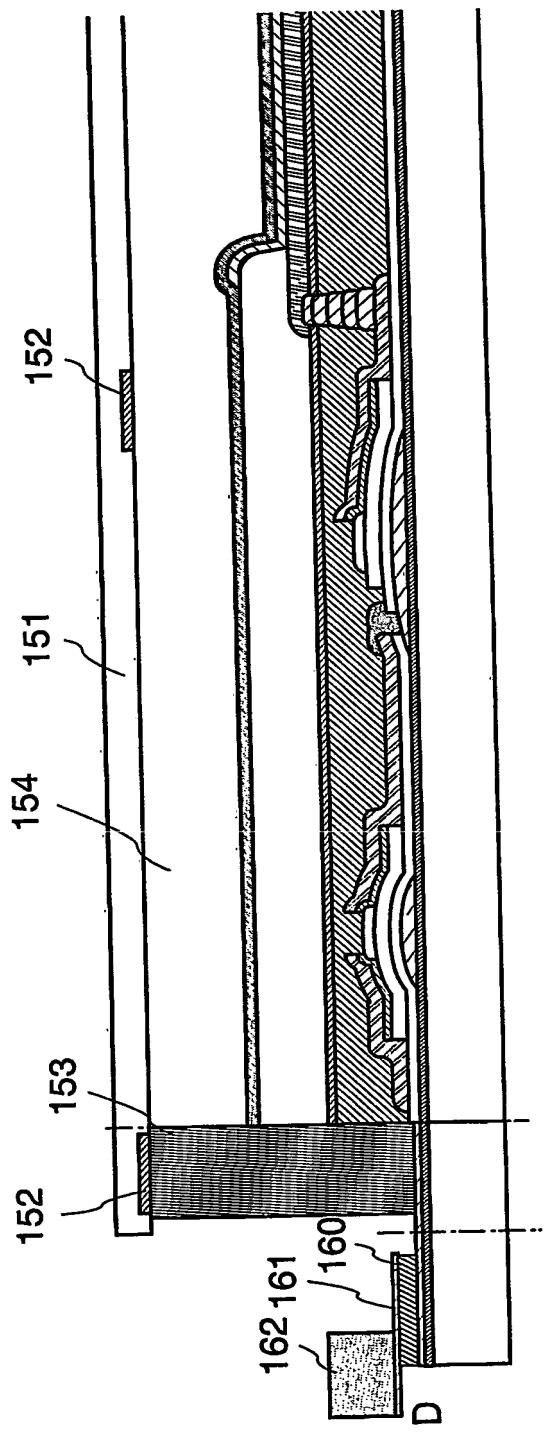
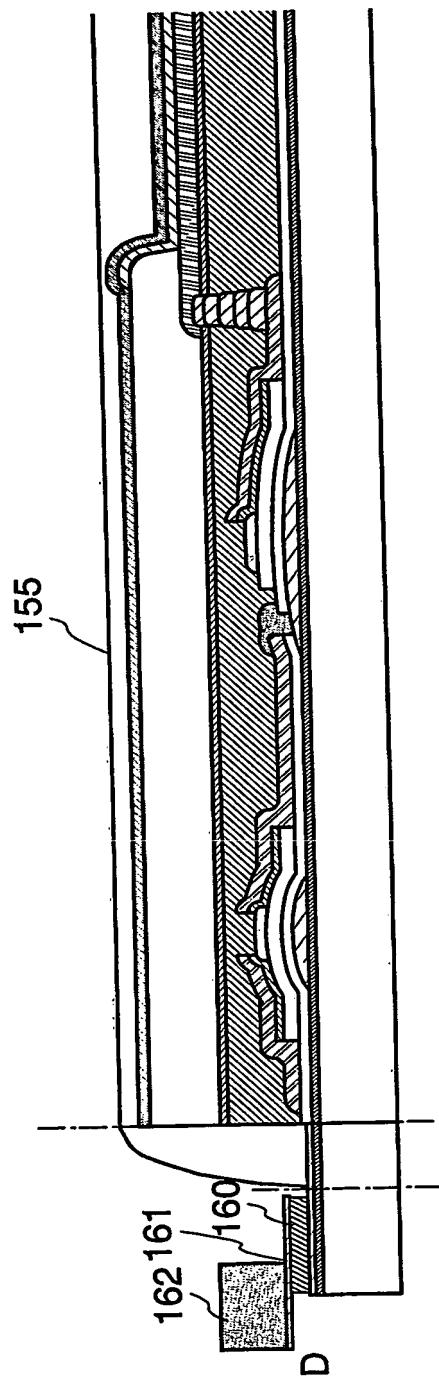


FIG. 12B



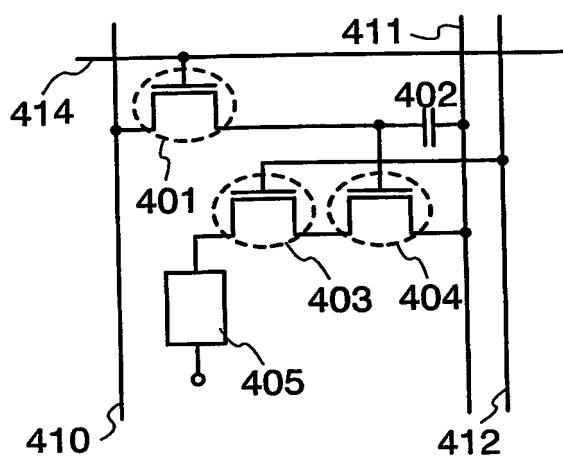
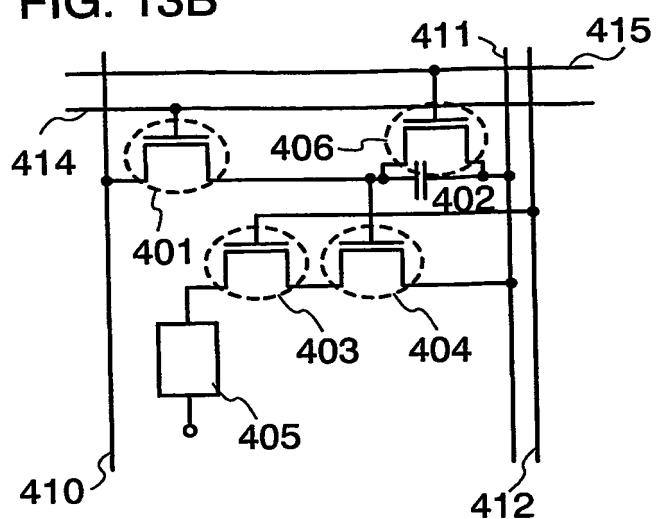
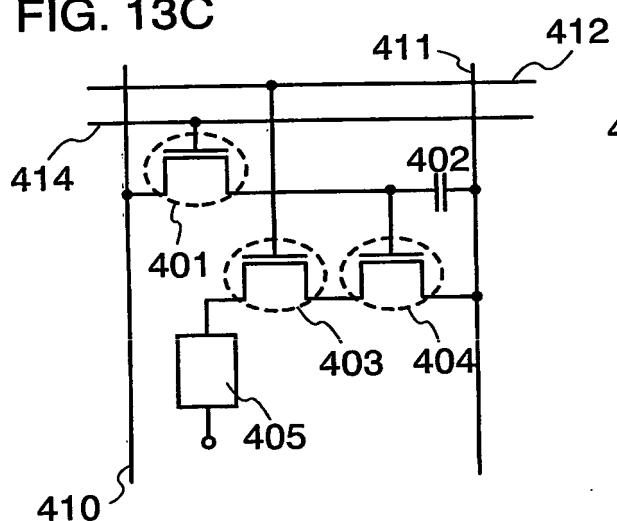
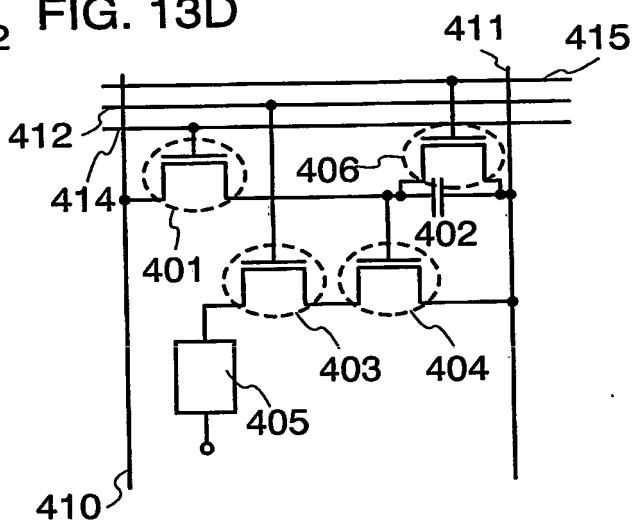
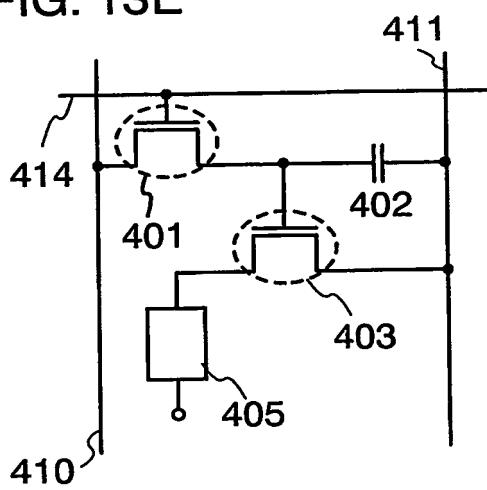
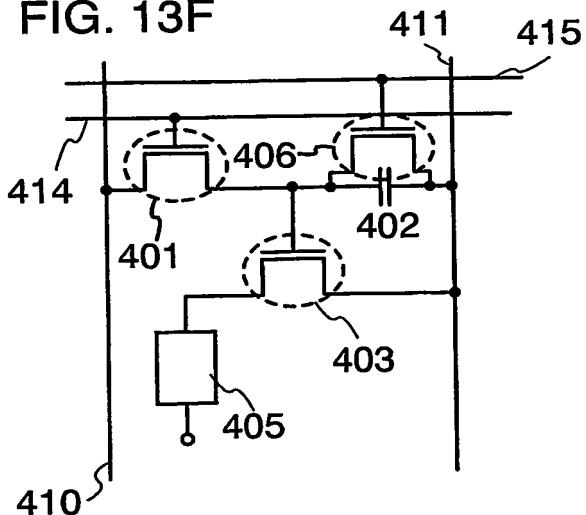
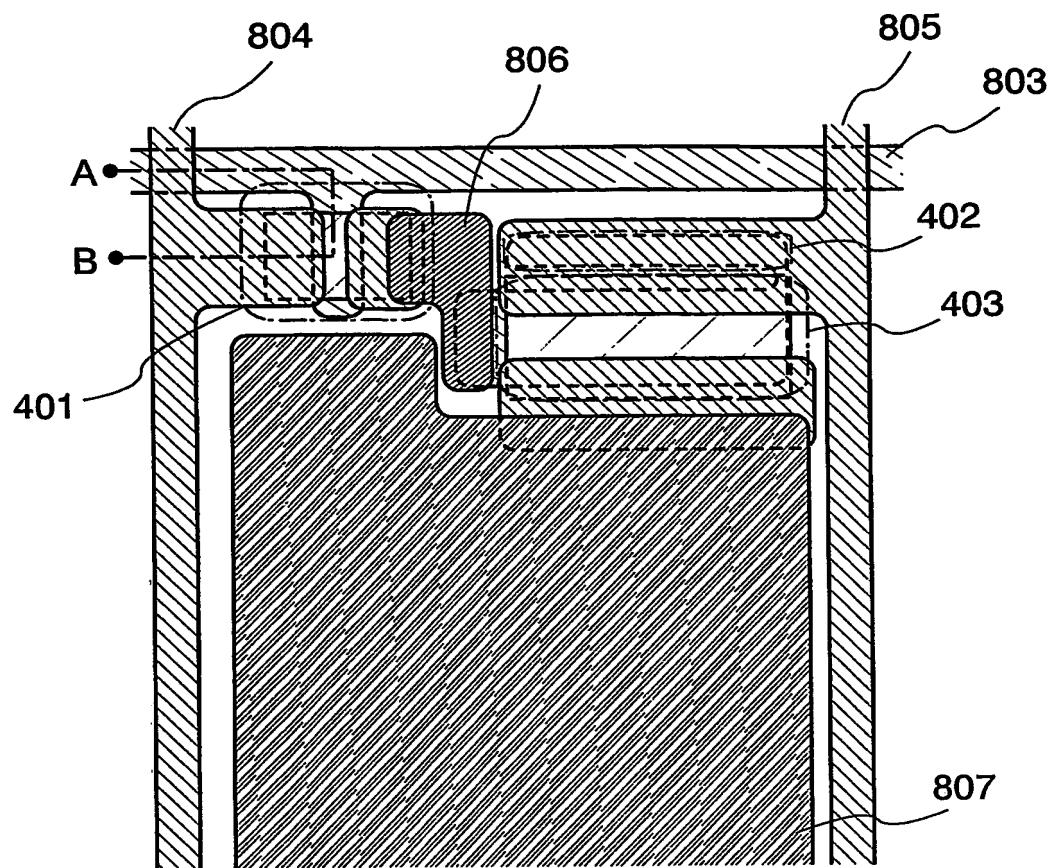
**FIG. 13A****FIG. 13B****FIG. 13C****FIG. 13D****FIG. 13E****FIG. 13F**

FIG. 14



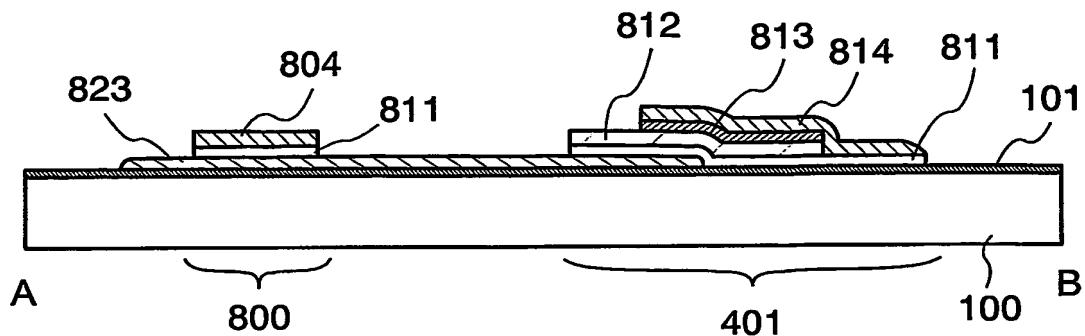
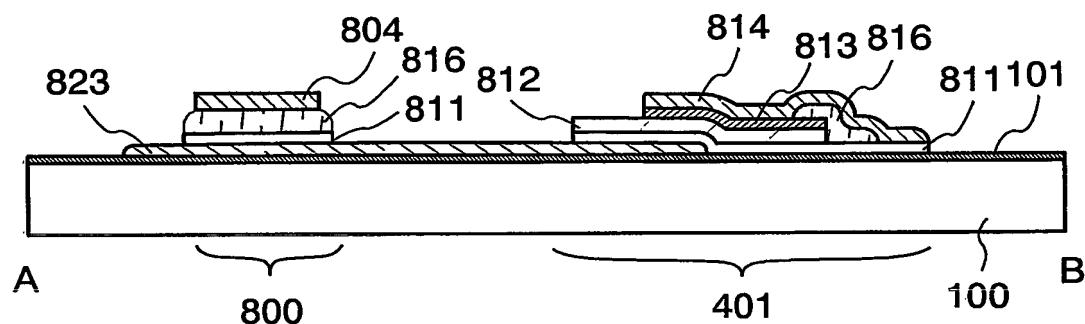
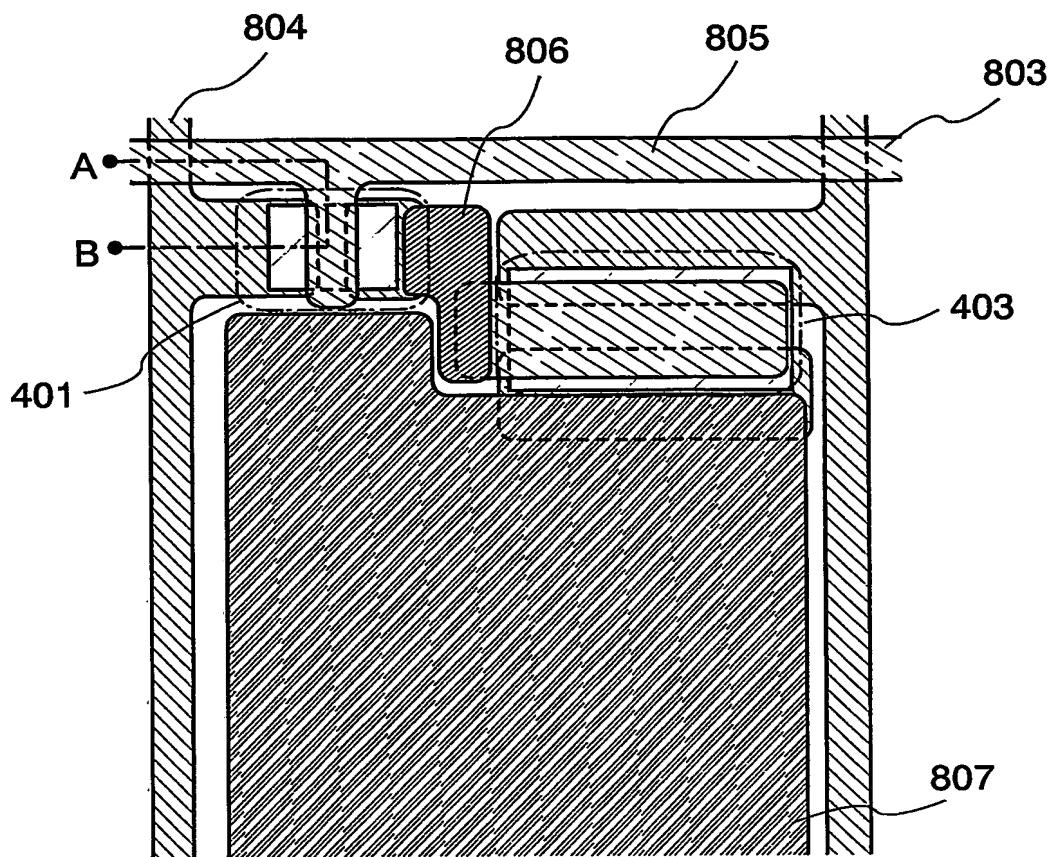
**FIG. 15A****FIG. 15B**

FIG. 16



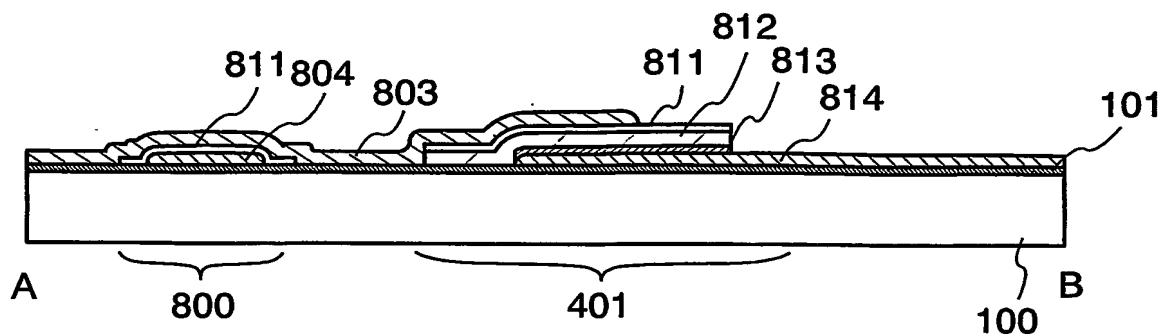
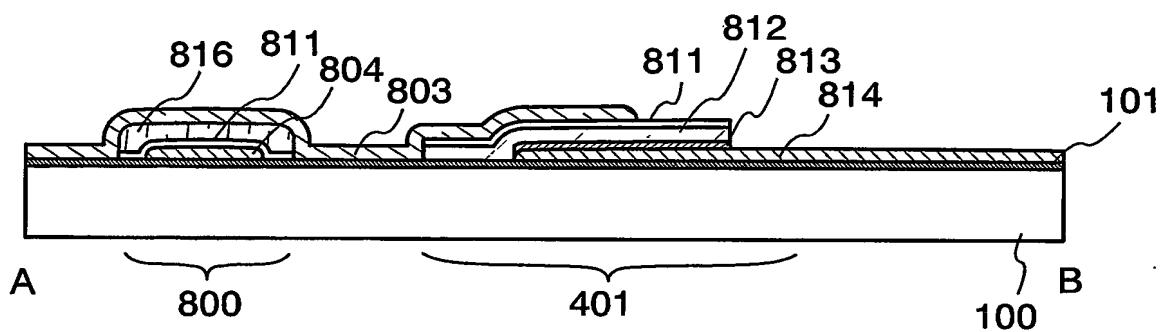
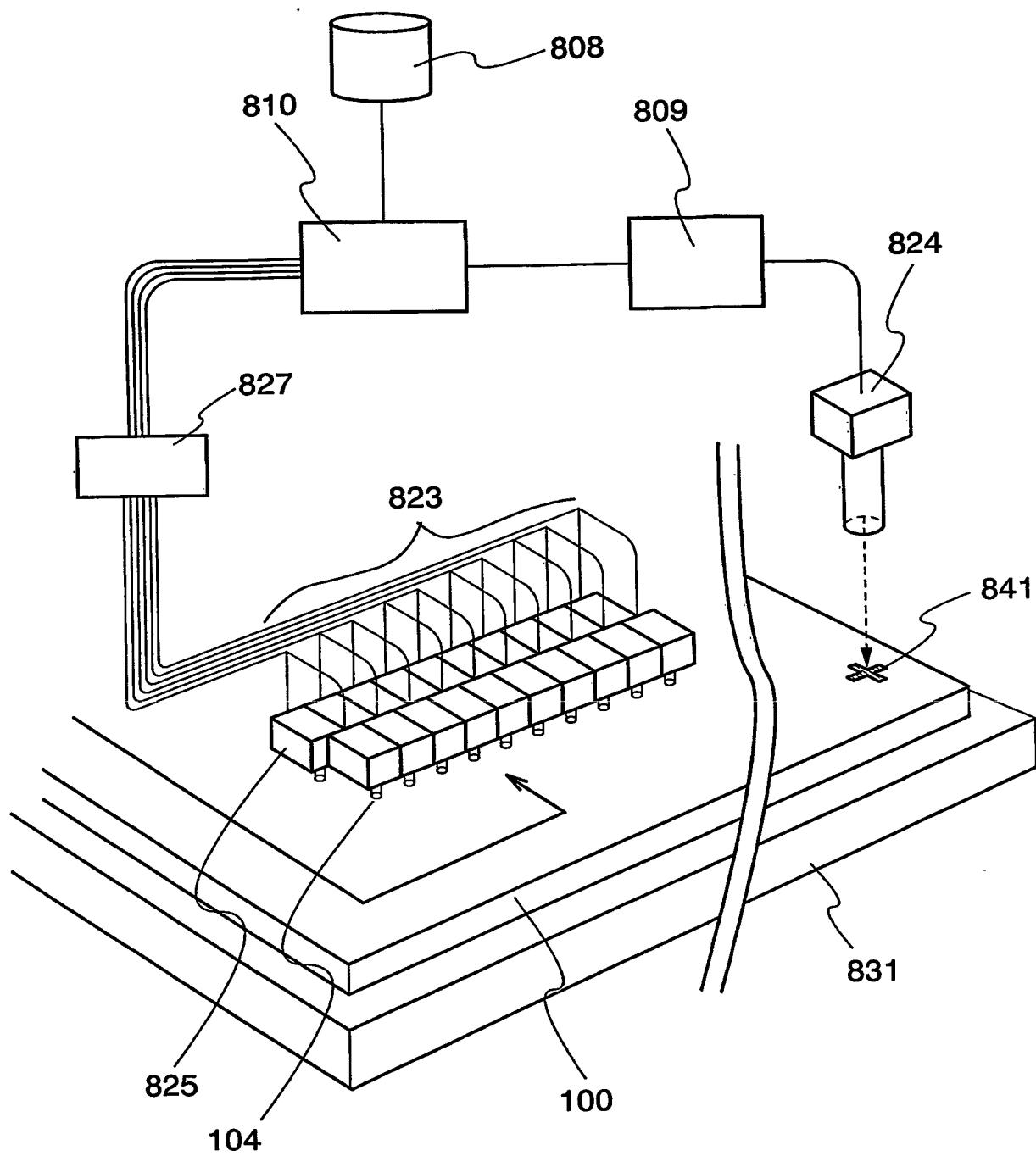
**FIG. 17A****FIG. 17B**

FIG. 18



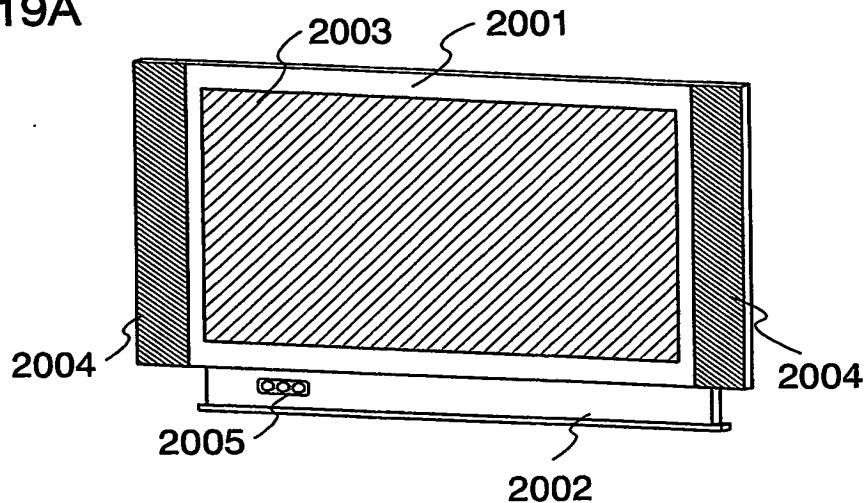
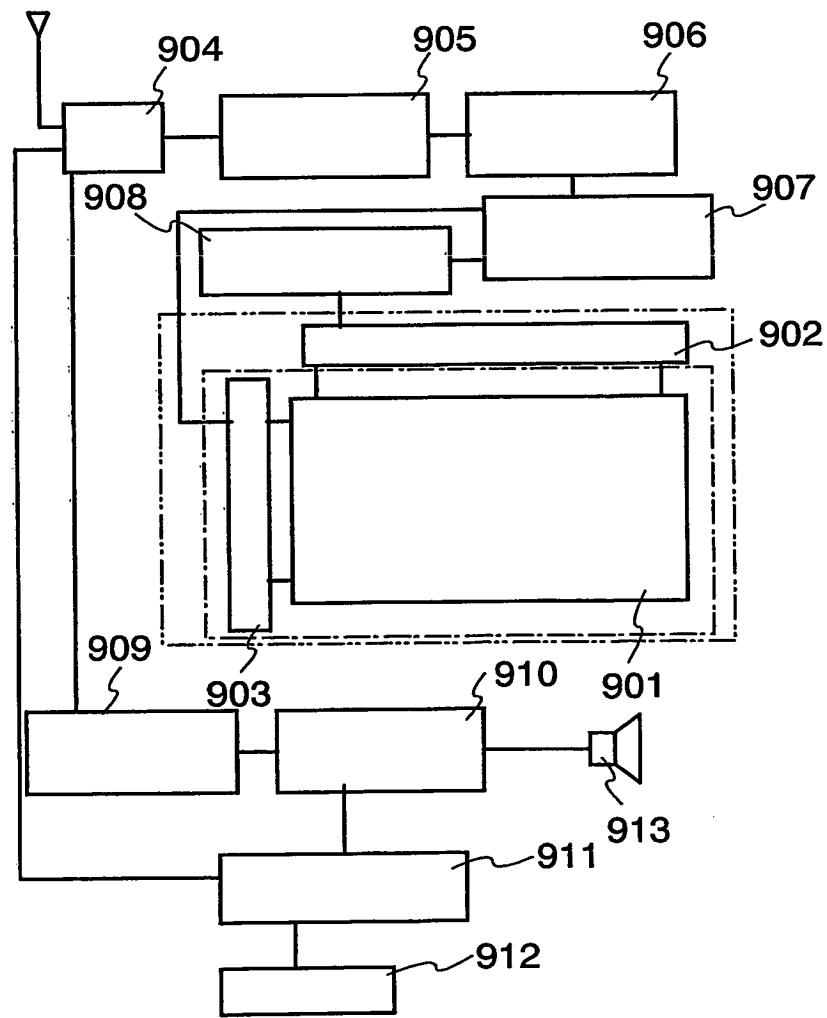
**FIG. 19A****FIG. 19B**

FIG. 20A

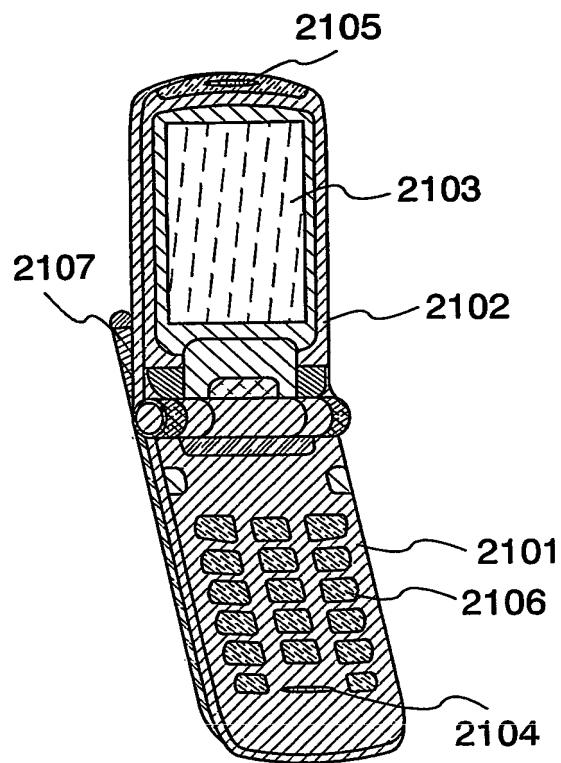


FIG. 20B

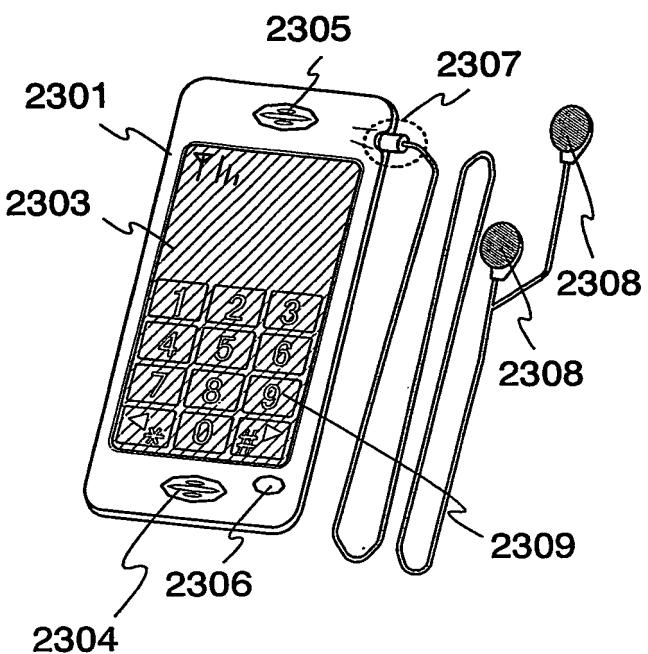


FIG. 21

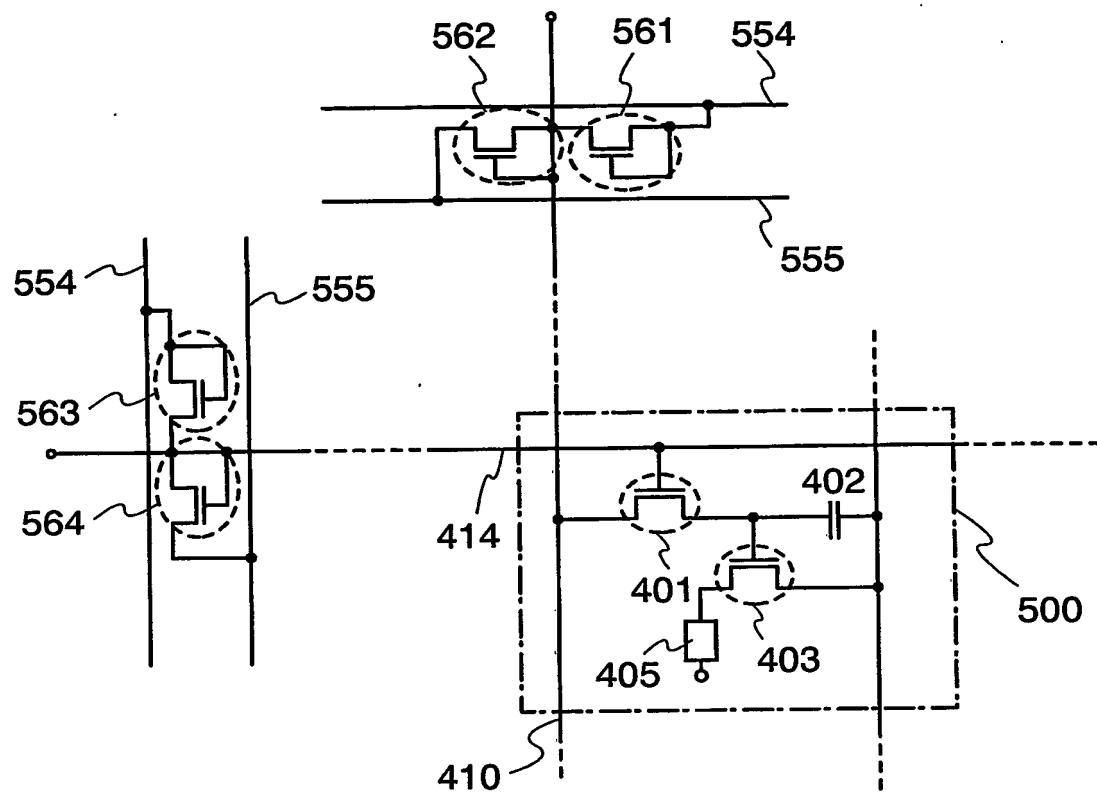


FIG. 22

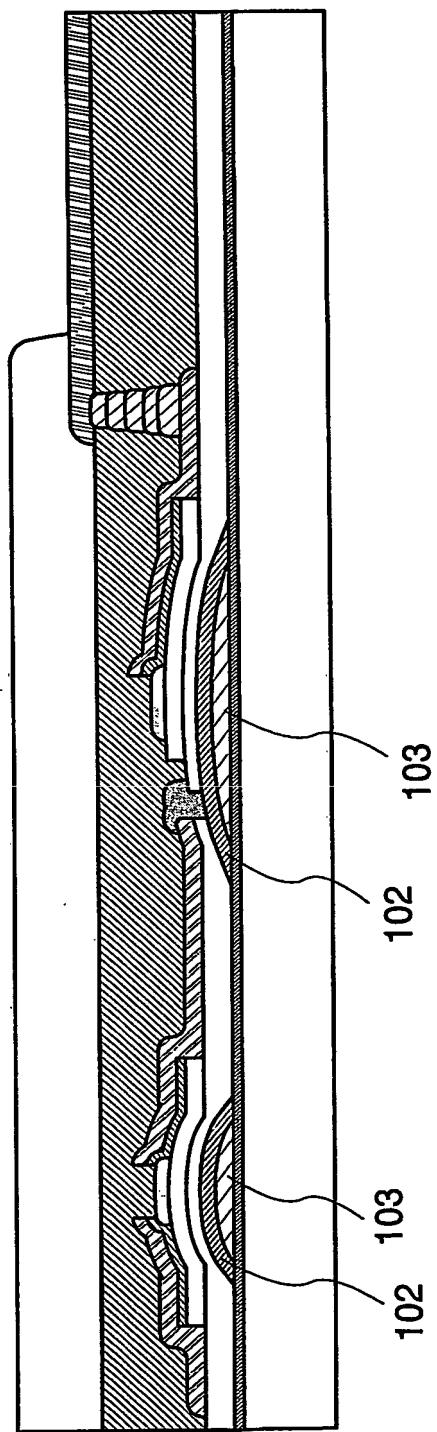


FIG. 23A

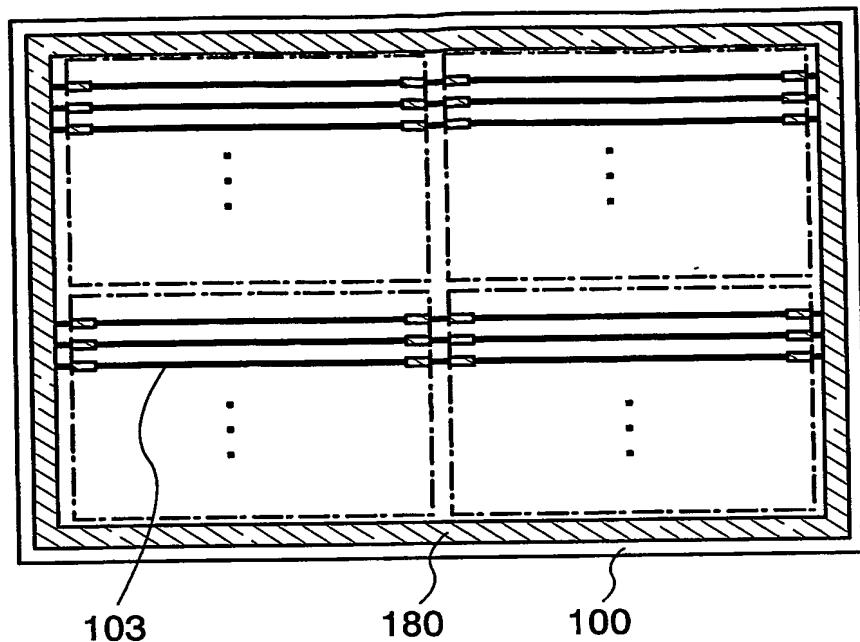


FIG. 23B

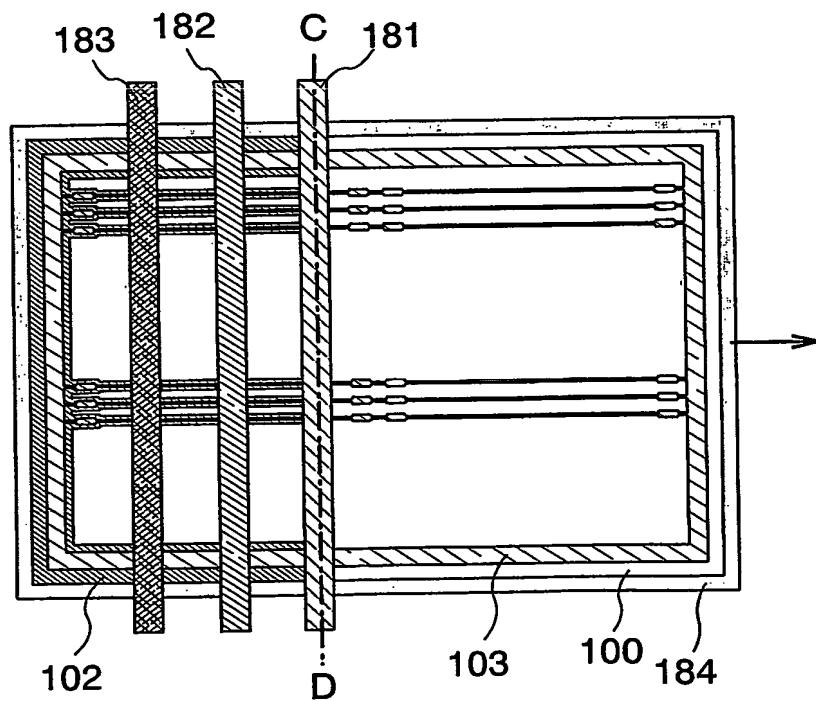
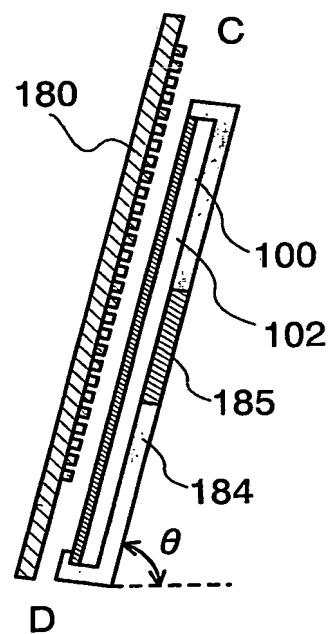
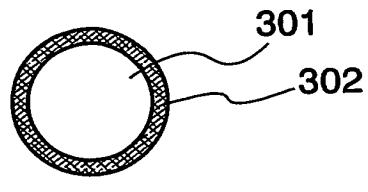
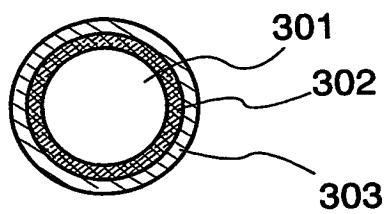
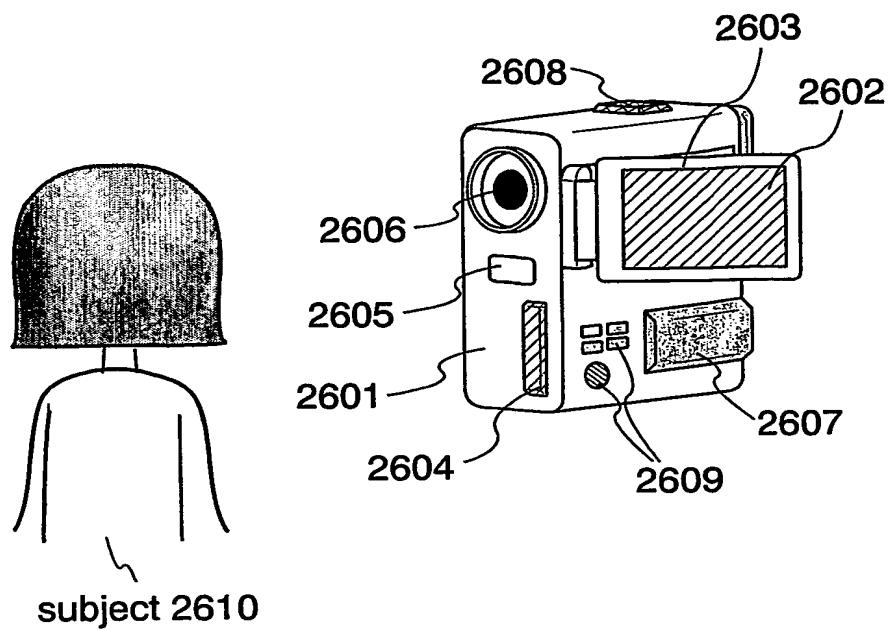
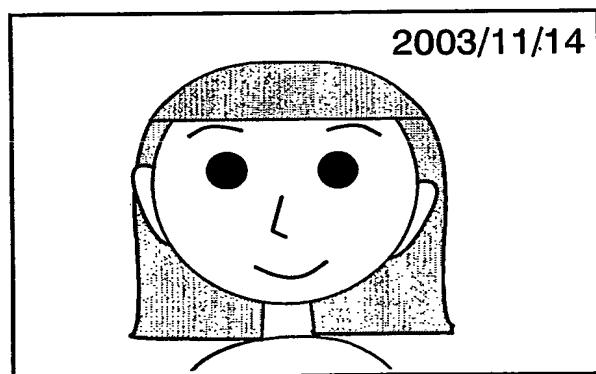
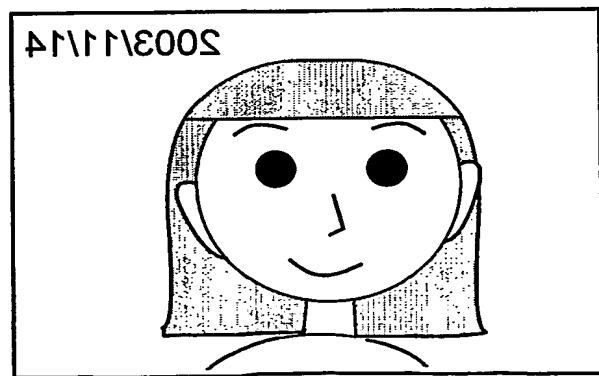
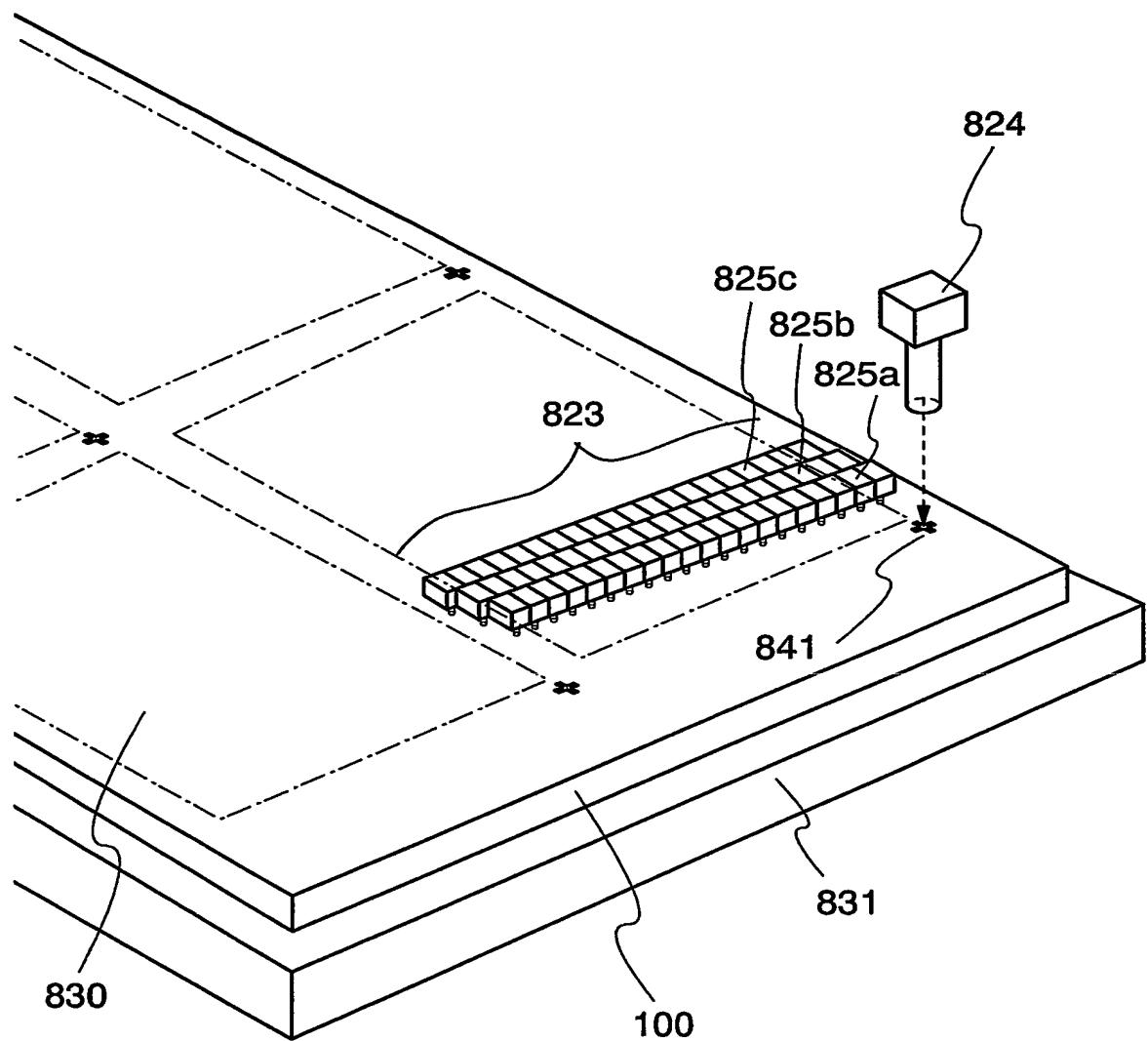


FIG. 23C



**FIG. 24A****FIG. 24B**

**FIG. 25A****FIG. 25B****FIG. 25C**

**FIG. 26**

Explanation of Reference

301 Cu, 302 conductor, 303 Ag, 100 substrate, 101 photocatalyst, 11 thin film transistor forming region, 12 thin film transistor forming region, 103 gate electrode, 104 nozzles, 105 gate insulating film, 106 semiconductor film, 109 semiconductor film, 111 mask, 5 115 drain electrode, 116 conductive film, 117 conductive film, 119 pixel electrode, 120 insulating film, 102 conductive film, 180 conductive film, 184 stage, 181 head, 182 head, 183 head, 185 insulator, 118 interlayer insulating film, 122 contact hole, 123 conductive film, 125 interlayer insulating film, 126 opening, 128 organic film, 129 contact hole, 136 film, 131 mask, 135 opening, 101 TiO<sub>x</sub> film, 130 insulating film, 150 10 means for spraying gas, 200 load chamber, 201 transfer chamber, 202 application treatment chamber, 203 transfer chamber, 204 planarization chamber, 132 silicon nitride film, 133 electroluminescent layer, 141 electroluminescent layer, 134 electrode, 132 electrode, 170 side of the substrate, 171 side of a sealing substrate, 153 sealant, 151 sealing substrate, 154 space, 152 desiccant, 160 anisotropic conductive film, 161 FPC, 15 162 external terminal, 410 signal line, 411 power line, 414 scan line, 401 switching TFT, 403 driving TFT, 404 current control TFT, 402 capacitor, 405 light emitting element, 412 power line, 406 erase TFT, 416 scan line, 415 scan line, 803 scan line, 804 signal line, 805 power line, 806 conductive film, 807 pixel electrode, 800 intersection region, 823 gate electrode, 811 gate insulating film, 812 semiconductor film, 813 20 semiconductor film, 814 drain electrode, 816 insulating film, 401 switching TFT, 500 pixel portion, 561 diode, 554 wiring, 823 droplet discharge means, 825 head, 827 control means, 810 computer, 831 stage, 841 marker, 824 imaging means, 809 image processing means, 808 storage medium, 100 large substrate, 830 intersection area, 825a head, 2001 chassis, 2002 support, 2003 display portion, 2004 speaker unit, 2005 video 25 signal input terminal, 901 pixel portion, 903 scan line driver circuit, 902 signal line driver circuit, 904 tuner, 905 video signal amplifier circuit, 906 video signal processing circuit, 907 control circuit, 908 signal division circuit, 909 audio signal amplifier circuit, 910 audio signal processing circuit, 913 speaker, 911 control circuit, 912 input portion, 2101 main body, 2102 chassis, 2103 display portion, 2104 audio input portion, 2105 30 audio output portion, 2106 operation keys, 2107 antenna, 2301 main body, 2303 display

portion, 2304 audio input portion, 2305 audio output portion, 2306 switch, 2307 external connection port, 2308 earphone, 2309 touch panel operation key, 2601 main body, 2602 display portion, 2603 chassis, 2604 external connection port, 2605 remote control receiving portion, 2606 image receiving portion, 2607 battery, 2608 audio input  
5 portion, 2609 operation keys, 2610 subject